

VS1220

16k Nonvolatile SRAM

FEATURES

- 10 years minimum data retention in the absence of external power
- Data is automatically protected during power loss
- Directly replaces 2k x 8 volatile static RAM or EEPROM
- Unlimited write cycles
- Low-power CMOS
- JEDEC standard 24-pin DIP package
- Read and write access times as fast as 100 ns
- Lithium energy source is electrically disconnected to retain freshness until power is applied for the first time
- Full ±10% V_{CC} operating range (VS1220AD)
- Optional ±5% V_{CC} operating range (VS1220AB)
- Optional industrial temperature range of -40°C to +85°C

PIN ASSIGNMENT

A7 01	24 0 VCC
A6 02	23 🔲 A6
AS 03	22 B A9
A4 84	21 B WE
A3 0 5	20 0 OE
A2 06	19 B A10
A1 07	18 E CE
AO BS	17 B DQ7
DQ0 00	16 DQ6
DQ1 10	15 0 005
DQ2 011	14 D DQ4
GND 112	130 DQ3

24-Pin ENCAPSULATED PACKAGE 720-mil EXTENDED

PIN DESCRIPTION

A0-A10	- Address Inputs
DQ0-DQ7	
CE	- Chip Enable
WE	- Write Enable
\overline{OE}	- Output Enable
V _{CC}	- Power (+5V)
GND	- Ground

DESCRIPTION

The VS1220AB and VS1220AD 16k Nonvolatile SRAMs are 16,384-bit, fully static, nonvolatile SRAMs organized as 2048 words by 8 bits. Each NV SRAM has a self-contained lithium energy source and control circuitry which constantly monitors V_{CC} for an out-of-tolerance condition. When such a condition occurs, the lithium energy source is automatically switched on and write protection is unconditionally enabled to prevent data corruption. The NV SRAMs can be used in place of existing 2k x 8 SRAMs directly conforming to the popular bytewide 24-pin DIP standard. The devices also match the pinout of the 2716 EPROM and the 2816 EEPROM, allowing direct substitution while enhancing performance. There is no limit on the number of write cycles that can be executed and no additional support circuitry is required for microprocessor interfacing.

READ MODE

The VS1220AB and VS1220AD execute a read cycle whenever WE (Write Enable) is inactive (high) and \overline{CE} (Chip Enable) and \overline{OE} (Output Enable) are active (low). The unique address specified by the 11 address inputs (A0-A10) defines which of the 2048 bytes of data is to be accessed. Valid data will be available to the eight data output drivers within t_{ACC} (Access Time) after the last address input signal is stable, providing that the \overline{CE} and \overline{OE} access times are also satisfied. If \overline{CE} and \overline{OE} access times are not satisfied, then data access must be measured from the later-occurring signal and the limiting parameter is either t_{CO} for \overline{CE} or t_{OE} for \overline{OE} rather than address access.

WRITE MODE

The VS1220AB and VS1220AD execute a write cycle whenever the \overline{WE} and \overline{CE} signals are active (low) after address inputs are stable. The latter occurring falling edge of \overline{CE} or \overline{WE} will determine the start of the write cycle. The write cycle is terminated by the earlier rising edge of \overline{CE} or \overline{WE} . All address inputs must be kept valid throughout the write cycle. \overline{WE} must return to the high state for a minimum recovery time (t_{WR}) before another cycle can be initiated. The \overline{OE} control signal should be kept inactive (high) during write cycles to avoid bus contention. However, if the output drivers are enabled (\overline{CE} and \overline{OE} active) then \overline{WE} will disable the outputs in t_{ODW} from its falling edge.

DATA RETENTION MODE

The VS1220AB provides full functional capability for V_{CC} greater than 4.75 volts and write protects by 4.5V. The VS1220AD provides full functional capability for V_{CC} greater than 4.5 volts and write protects by 4.25V. Data is maintained in the absence of V_{CC} without any additional support circuitry. The nonvolatile static RAMs constantly monitor V_{CC} . Should the supply voltage decay, the NV SRAMs automatically write protect themselves, all inputs become "don't care," and all outputs become high impedance. As V_{CC} falls below approximately 3.0 volts, a power switching circuit connects the lithium energy source to RAM to retain data. During power-up, when V_{CC} rises above approximately 3.0 volts, the power switching circuit connects external V_{CC} to RAM and disconnects the lithium energy source. Normal RAM operation can resume after V_{CC} exceeds 4.75 volts for the VS1220AB and 4.5 volts for the VS1220AD.

FRESHNESS SEAL

Each VS1220 device is shipped with its lithium energy source disconnected, guaranteeing full energy capacity. When V_{CC} is first applied at a level of greater than V_{TP} , the lithium energy source is enabled for battery backup operation.

ABSOLUTE MAXIMUM RATINGS*

Voltage on Any Pin Relative to Ground	-0.3V to +7.0V					
Operating Temperature 0°C to 70°C;	-40° C to $+85^{\circ}$ C for	IND part	S			
Storage Temperature	-40°C to +70°C;	-40°C	to	+85°C	for	IND
Soldering Temperature	260°C for 10 secon	nds				

RECOMMENDED DC OPERATING CONDITIONS (T_A: See Note 10)

PARAMETER	SYMBOL	MIN	ТҮР	MAX	UNITS	NOTES
DS1220AB Power Supply Voltage	Vcc	4.75	5.0	5.25	V	
DS1220AD Power Supply Voltage	Vcc	4.50	5.0	5,50	V	
Logic 1	VIH	2.2		Vcc	V	
Logic 0	VIL	0.0		+0.8	V	

(T_A: See Note 10)

(V_{CC}\!=\!\!5V\pm5\% for VS1220AB)

DC ELECTRICAL CHARACTERISTICS

(V_{CC} =5V \pm 10% for VS1220AD)

PARAMETER	SYMBOL	MIN	ТҮР	MAX	UNITS	NOTES
Input Leakage Current	IIL	-1.0		+1.0	μΑ	
IO Leakage Current $\overline{CE} \ge V_{IH} \le V_{CC}$	$I_{\rm IO}$	-1.0		+1.0	μA	
Output Current @ 2.4V	I _{OH}	-1.0			mA	
Output Current @ 0.4V	IoL	2.0			mA	
Standby Current $\overline{CE} = 2.2V$	I _{CCS1}		5.0	10.0	mA	
Standby Current $\overline{CE} = V_{CC}-0.5V$	I _{CCS2}		3.0	5.0	mA	
Operating Current (Commercial)	I _{CC01}			75	mA	
Operating Current (Industrial)	Iccoi			85	mA	
Write Protection Voltage (DS1220AB)	V_{TP}	4.5	4.62	4.75	V	
Write Protection Voltage (DS1220AD)	V_{TP}	4.25	4.37	4.5	V	

CAPACITANCE

(T_A=25°C)

PARAMETER	SYMBOL	MIN	ТҮР	MAX	UNITS	NOTES
Input Capacitance	CIN		5	10	pF	
Input/Output Capacitance	CI/O		5	12	pF	

(T_A : See Note 10)

(V_{CC} =5.0V \pm 5% for VS1220AB)

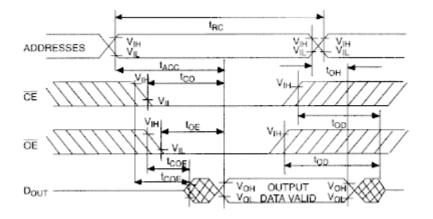
AC ELECTRICAL CHARACTERISTICS (V $_{CC}$ =5.0V \pm 10% for VS1220AD)

PARAMETER	SYMBOL	1220AB-100 SYMBOL 1220AD-100			0AB-120 0AD-120	UNITS	NOTES
		MIN	MAX	MIN	MAX		
Read Cycle Time	LRC	100		120		ns	
Access Time	tacc		100		120	ns	
OE to Output Valid	tos		50		60	ns	
CE to Output Valid	tco		100		120	ns	
OE or CE to Output Active	tcon	5		5		ns	5
Output High Z from Deselection	top		35		35	ns	5
Output Hold from Address Change	tott	5		5		ns	
Write Cycle Time	twc	100		120		ns-	
Write Pulse Width	twp	75		90		ns	3
Address Setup Time	1 _{AW}	0	(S	0		ns	
Write Recovery Time	twr.i twr.z	0 10		0 10		ns ns	12 13
Output High from WE	topw		35		35	ns	5
Output Active from WE	toew	5		5		ns	4
Data Setup Time	tos	40		50		ns	4
Data Hold Time	toni toniz	0 10		0 10		ns ns	12

AC ELECTRICAL CHARACTERISTICS

PARAMETER	SYMBOL	100000	0AB-150 0AD-150		0AB-200 0AD-200	UNITS	NOTES
	THE SHORE	MIN	MAX	MIN	MAX	12122000	
Read Cycle Time	t _{RC}	150		200		ns	
Access Time	LACC		150		200	ns	
OE to Output Valid	toE		70		100	ns	
CE to Output Valid	tco		150		200	ns	
OE or CE to Output Active	t _{COE}	5		5		ns	5
Output High Z from Deselection	top		35		35	ns	5
Output Hold from Address Change	ton	5		5		ns	
Write Cycle Time	twc	150		200		ns	2
Write Pulse Width	twp	100		150		ns	3
Address Setup Time	tAW	0		0		ns	
Write Recovery Time	twiki	0		0		ns	12
	LWR2	10		10		ns	13
Output High Z from WE	toow		35		35	ns	5
Output Active from WE	t _{OEW}	5		5		ns	4
Data Setup Time	tos	60	5	50		ns	4
Data Hold Time	(DH1	0		0		ns	12
Paral de la companya	t _{DH2}	10		10		ns	13

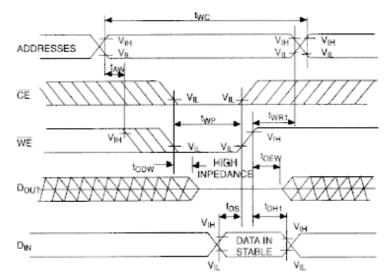
READ CYCLE



SEE NOTE 1

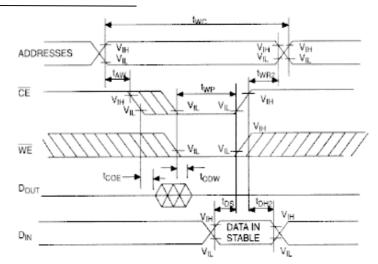
(cont'd)

WRITE CYCLE 1



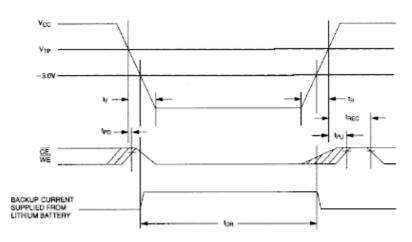
SEE NOTES 2, 3, 4, 6, 7, 8 AND 12

WRITE CYCLE 2



SEE NOTES 2, 3, 4, 6, 7, 8 AND 13

POWER-DOWN/POWER-UP CONDITION



SEE NOTE 11

POWER-DOWN/POWER-UP TIMING

(T_A: See Note 10)

PARAMETER	SYMBOL	MIN	ТҮР	MAX	UNITS	NOTES
V_{CC} Fail Detect to \overline{CE} and \overline{WE} Inactive	t _{PD}			1.5	μs	11
V_{CC} slew from V_{TP} to θV	$t_{\rm F}$	300			μs	
V_{CC} slew from 0V to V_{TP}	t _R	300			μs	
V_{CC} Valid to \overline{CE} and \overline{WE} Inactive	t _{PU}			2	ms	
V _{CC} Valid to End of Write Protection	t _{REC}			125	ms	

(T_A=25°C)

PARAMETER	SYMBOL	MIN	ТҮР	MAX	UNITS	NOTES
Expected Data Retention Time	t _{DR}	10			years	9

WARNING:

Under no circumstances are negative undershoots, of any amplitude, allowed when device is in the battery backup mode.

NOTES:

- 1. \overline{WE} is high for a read cycle.
- 2. \overline{OE} = V_{IH} or V_{IL}. If \overline{OE} = vIH during write cycle, the output buffers remain in a

high-impedance state.

3. t_{WP} is specified as the logical AND of \overline{CE} and \overline{WE} . t_{WP} is measured from the latter of \overline{CE}

or CE going low to the earlier of CE or WE going high.

- 4. t_{DS} is measured from the earlier of *CE* or *WE* going high.
- 5. These parameters are sampled with a 5 pF load and are not 100% tested.
- 6. If the *CE* low transition occurs simultaneously with or later than the *WE* low transition, the output buffers remain in a high-impedance state during this period.
- 7. If the *CE* high transition occurs prior to or simultaneously with the *WE* high transition, the output buffers remain in a high-impedance state during this period.
- 8. If \overline{WE} is low or the \overline{WE} low transition occurs prior to or simultaneously with the *CE* low transition, the output buffers remain in a high-impedance state during this period.
- 9. Each VS1220AB and each VS1220AD has a built-in switch that disconnects the lithium source until V_{CC} is first applied by the user. The expected t_{DR} is defined as accumulative time in the absence of V_{CC} starting from the time power is first applied by the user.
- 10. All AC and DC electrical characteristics are valid over the full operating temperature range. For commercial products, this range is 0°C to 70°C. For industrial products (IND), this range is -40°C to +85°C.
- 11. In a power down condition the voltage on any pin may not exceed the voltage on V_{CC} .

12. t_{WR1}, t_{DH1} are measured from *WE* going high.

13. t_{WR2} , t_{DH2} are measured from *CE* going high.

DC TEST CONDITIONS

Outputs Open Cycle = 200ns for Operating Current All Voltages Are Referenced to Ground

AC TEST CONDITIONS

Output Load: 100 pF + 1TTL Gate Input Pulse Levels: 0 - 3.0V Timing Measurement Reference Levels Input: 1.5V Output: 1.5V Input Pulse Rise and Fall Times: 5ns VS1220AB/AD NONVOLATILE SRAM, 24-PIN 720-MIL EXTENDED

MODULE

